

SMB1N-1050-02

- Infrared High Power LED
- 1050 nm, 35 mW
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 5.5 mm
- Viewing Angle: 20°

Description





Rev. 1.4, 19.12.2018

SMB1N-1050-02 is a surface mount InGaAsP High Power LED with a typical peak wavelength of **1050 nm** and radiation of **35mW**. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

Maximum Ratings (T_{CASE}=25°C)

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Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		1000	mW	
Forward Current	lF		600	mA	
Pulse Forward Current *1	IFP		2000	mA	
Reverse Voltage	VF		5	V	
Thermal Resistance	Rthja		10	K/W	
Junction Temperature	T_J		100	°C	
Operating Temperature	TCASE	- 40	+ 85	°C	
Storage Temperature	TSTG	- 40	+ 100	°C	
Lead Solder Temperature *2	T _{SLD}		+ 250	°C	

*1 duty=1%, pulse width = 10 μ s

*2 must be completed within 5 seconds

Electro-Optical Characteristics (TCASE=25°C)

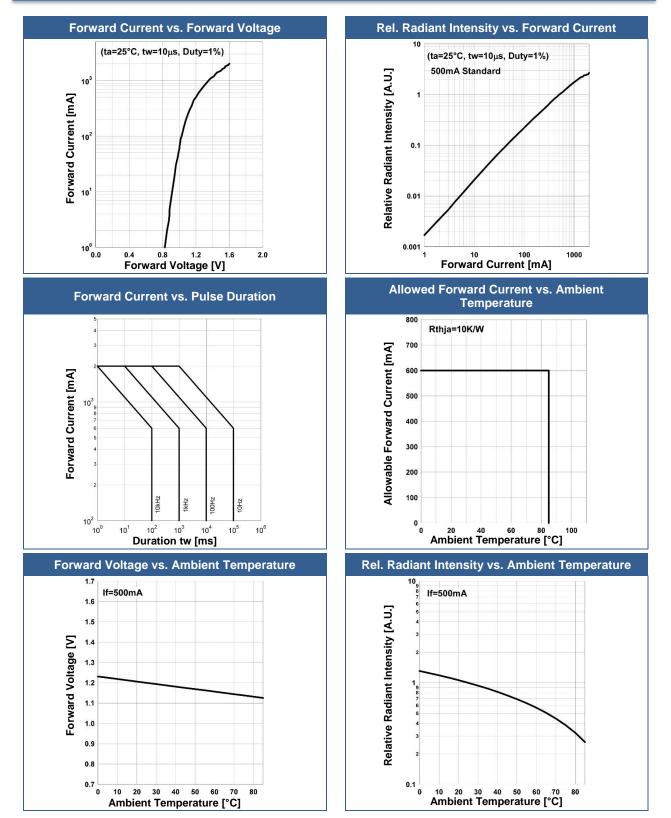
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I⊧=500mA	1000		1100	nm
Half Width	$\Delta \lambda$	I⊧=500mA		48		nm
Forward Voltage	VF	I _F =500mA		1.2	1.65	V
	VFP	IFP=2A		1.6	3.5	
Radiated Power *1	Po	I⊧=500mA		35		mW
	FO	IFP=2A		94		
Radiant Intensity *2	IE	I⊧=500mA		80		mW/sr
	IE	IFP=2A		210		
Viewing Angle	φ	I _F =100mA		20		deg.
Rise Time	t _R	I⊧=500mA		120		ns
Fall Time	t _F	I _F =500mA		80		ns

*1 measured by G8370-85

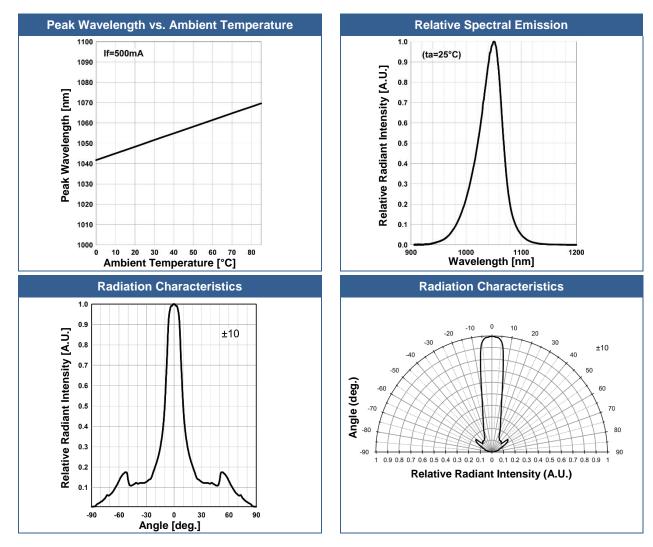
*2 measured by ANDO Optical Multi Meter AQ2140 & AQ2743



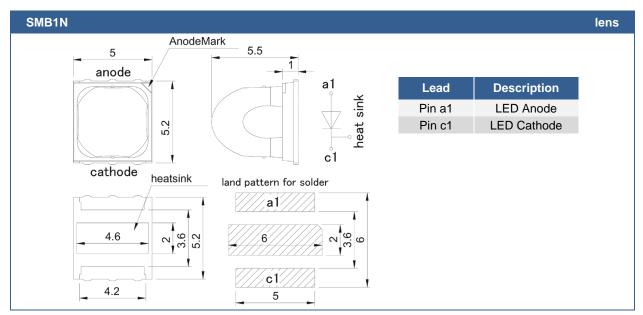
Typical Performance Curves







Outline Dimensions



All Dimensions in mm



Precautions

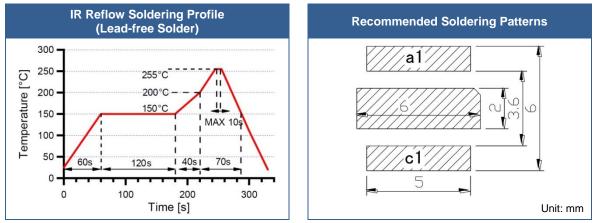
Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- · Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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The above specifications are for reference purpose only and subjected to change without prior notice